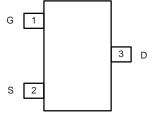


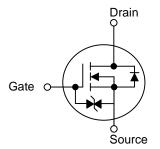
N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (mA)				
60	2.5 at V _{GS} = 10 V	200				









FEATURES

- Low On-Resistance: 2.5 Ω
- Low Threshold: 2 V (typ.)
- Low Input Capacitance: 25 pF
- Fast Switching Speed: 25 ns
- Low Input and Output Leakage
- DT-Trench Power MOSFET
- 1200V ESD Protection

BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- Easily Driven Without Buffer
- High-Speed Circuits
- Low Error Voltage

APPLICATIONS

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted									
Parameter		Symbol	Limit	Unit					
Drain-Source Voltage		V _{DS}	60	V					
Gate-Source Voltage		V _{GS}	± 20	v					
Continuous Desis Querent (T. 150 °C)	T _A = 25 °C	I.	200	mA					
Continuous Drain Current (T _J = 150 °C) ^b	T _A = 100 °C	Ι _D	150						
Pulsed Drain Current ^a	I _{DM}	700							
Deven Directory b	T _A = 25 °C	PD	0.15	W					
Power Dissipation ^b	T _A = 100 °C	۲D	0.07						
Maximum Junction-to-Ambient ^b		R _{thJA}	390	°C/W					
Operating Junction and Storage Temperature Range		$T_{J,}T_{stg}$	- 55 to 150	°C					

Notes:

a. Pulse width limited by maximum junction temperature.

b. Surface Mounted on FR4 board.



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SPECIFICATIONS T _A = 25 °C, unless otherwise noted									
Parameter		Test Conditions	Limits						
	Symbol		Min.	Typ. ^a	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_{D} = 10 \mu A$	60			- v			
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		2.5				
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 10	μA			
		$V_{DS} = 0 V, V_{GS} = \pm 15 V$			1				
	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 10 V$			± 150	nA			
		$V_{DS} = 0 V, V_{GS} = \pm 10 V, T_{J} = 85 °C$			± 1000				
		$V_{DS} = 0 V, V_{GS} = \pm 5 V$			± 100				
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA			
	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V , T_{J} = 125 °C			500				
On-State Drain Current ^a		V_{GS} = 10 V, V_{DS} = 7.5 V	700			mA			
	I _{D(on)}	V_{GS} = 4.5 V, V_{DS} = 10 V	300						
Drain-Source On-Resistance ^a	Р	V _{GS} = 10 V, I _D = 100 mA			2.5	Ω			
	R _{DS(on)}	V_{GS} = 4.5 V, I _D = 100 mA			4				
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 100 mA	100			mS			
Diode Forward Voltage	V _{SD}	I _S = 100 mA, V _{GS} = 0 V			1.3	V			
Dynamic ^a				•					
Total Gate Charge	Qg	V_{DS} = 10 V, V_{GS} = 4.5 V I _D \cong 100 mA		0.4	0.6	nC			
Input Capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V f = 1 MHz		30		pF			
Output Capacitance	C _{oss}			6					
Reverse Transfer Capacitance	C _{rss}			2.5					
Switching ^{a, b, c}									
Turn-On Time	t _{d(on)}	$V_{\text{DD}} = 30 \text{ V}, \text{ R}_{\text{L}} = 150 \Omega$ $\text{I}_{\text{D}} \cong 100 \text{ mA}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{G}} = 10 \Omega$			25	ns			
Turn-Off Time	t _{d(off)}				35				

Notes:

a. For DESIGN AID ONLY, not subject to production testing. b. Pulse test: PW \leq 300 µs duty cycle \leq 2 %.

c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

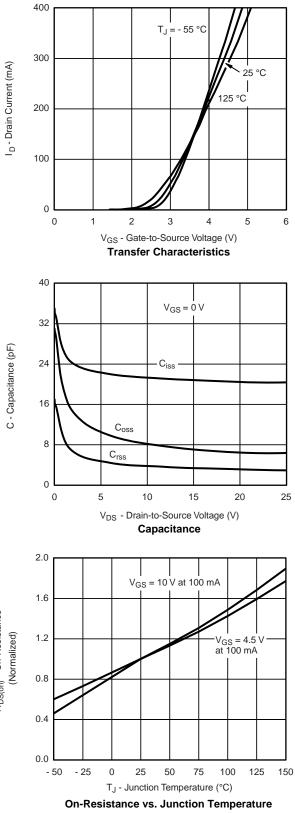


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

1.0 7 V 6 V V_{GS} = 10 V 0.8 5 V I_D - Drain Current (A) 0.6 4 V 0.4 0.2 3 V 0.0 1 2 3 4 0 5 V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics** 8.0 7.0 $R_{DS(on)}$ - On-Resistance (Ω) 6.0 5.0 V_{GS} = 4.5 V 4.0 3.0 V_{GS} = 10 V 2.0 1.0 0.0 0 100 200 300 400 500 I_D - Drain Current (mA) **On-Resistance vs. Drain Current** 7 V_{DS} = 10 V 6 V_{GS} - Gate-to-Source Voltage (V) $I_{\rm D} = 1000 \, {\rm mA}$ R_{DS(on)} - On-Resistance 5 4 3 2 1 0 0.0 0.1 0.2 0.3 0.4 0.5 0.6 Q_q - Total Gate Charge (nC)

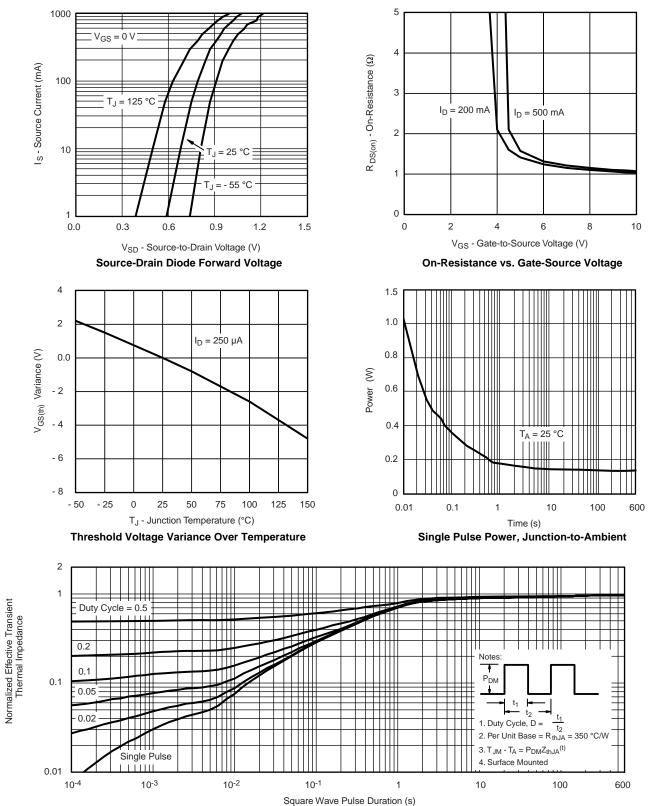
Gate Charge



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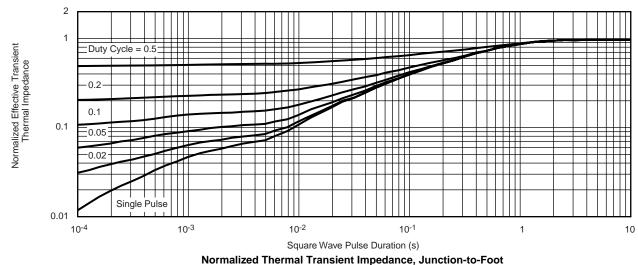




Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Foot (25 C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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